

## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

Sheet	A1	of	A1
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Application Number	10/689,976
Filing Date	October 21, 2003
First Named Inventor	Glenn A. Rinne
Group Art Unit	2811
Examiner Name	
Attorney Docket Number	9180-24

[illegible][illegible]

Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	T
<i>JEI</i>	6.	International Search Report for PCT/US 03/33211.	

penyer E. Matias

12-6-05

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Substitute form 1449A/PTO				<b>Complete if Known</b>	
<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>  (use as many sheets as necessary)				Application Number	not yet assigned
				Filing Date	concurrently
				First Named Inventor	Glenn A. Rinne
				Group Art Unit	
				Examiner Name	not yet assigned
Sheet	1	of	1	Attorney Docket Number	9180-24

U.S. PATENTS AND PATENT PUBLICATIONS					
Examiner Initials*	Cite No.	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY
		Number	Kind Code (if known)		
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	2.	US-3,501,681		Weir	03/17/1970
	3.	US-3,663,184		Wood et al;	05/16/1972
	4.	US-3,760,238		Hamer et al;	09/18/1973
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JEM	47.		55-111127		Japan (English Abstract)	08/1980
JEM	48.		57-73952		Japan	05/1982
Examiner Signature		<i>James E. Mortimer</i>			Date Considered	12-6-05

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JEM	49.	57-73952	Japan (English Abstract)	5/1982	
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<b>OTHER NON PATENT LITERATURE DOCUMENTS</b>					
Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published			T
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Examiner Signature	<i>Jennifer E. Matulich</i>	Date Considered	12-6-05
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